

INFORMATION DISCLOSURE STATEMENT

Applicant : Tomohide BANBA et al.
App. No : 10/565,565
Filed : January 23, 2006
For : AN INORGANIC POWDER-CONTAINING
RESIN COMPOSITION, A FILM-FORMING
MATERIAL LAYER, A TRANSFER SHEET,
METHOD OF PRODUCING A SUBSTRATE
HAVING A DIELECTRIC LAYER FORMED
THEREON, AND A SUBSTRATE HAVING A
DIELECTRIC LAYER FORMED THEREON
Examiner : SZEKELY, Peter A.
Art Unit : 1796

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 3 references to be considered by the Examiner. Also enclosed are 3 foreign patent references and/or non-patent literature as listed on the Information Disclosure Statement.

This Information Disclosure Statement is being filed before the mailing date of a final action and before the mailing date of a Notice of Allowance.

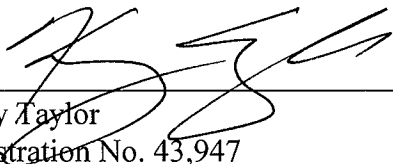
CERTIFICATION UNDER 37 C.F.R. § 1.97(e)(1)

I hereby certify that each item of information contained in this Statement was first cited in a communication from a foreign Patent Office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

Thus, no fee is required as set forth in 37 C.F.R. § 1.97(c), however, the Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

Respectfully submitted,
KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 19-Dec-07

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